LNJ936W8CRA

Hight Bright Surface Mounting Chip LED

ESS Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	65	mW	
Forward current	I_{F}	15	mA	
Pulse forward current *	I_{FP}	55	mA	
Reverse voltage	V_R	5	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

■ Lighting Color

• Blue

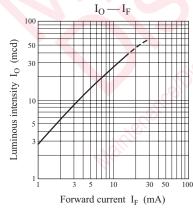
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

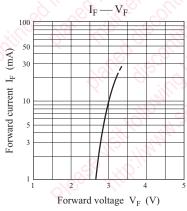
■ Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

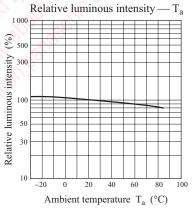
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I _O	$I_F = 5 \text{ mA}$	0,000	8.5	14.0	24.6	mcd
Reverse current	I_R	$V_R = 5 V$				10	μΑ
Forward voltage	V _F	$I_F = 5 \text{ mA}$	1000		2.9	3.2	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 5 \text{ mA}$	illes ille		465	ijoli	nm
Dominant emission wavelength *2	λ_{d}	$I_F = 5 \text{ mA}$	" " " " " " " " " " " " " " " " " " "	467	472	477	nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$	Pille Sign	2	20	18/1	nm

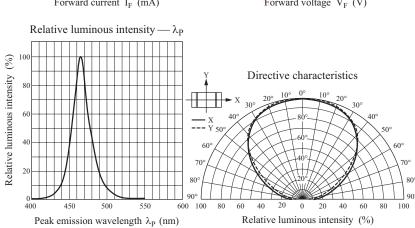


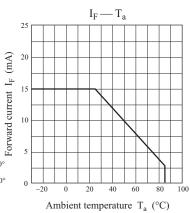








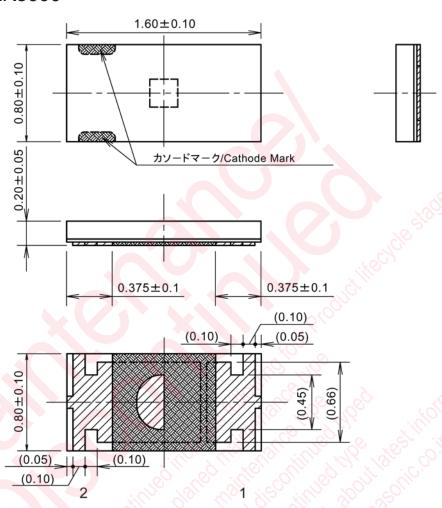




LNJ936W8CRA Panasonic

■ Package (Unit: mm)

KLTFTN2K3600



- Pin name
 - 1: Anode
 - 2: Cathode

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